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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Active
Number of LABs/CLBs	2880
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	203
Number of Gates	48000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	-55°C ~ 125°C (TC)
Package / Case	256-LBGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a54sx32a-fgg256m">https://www.e-xfl.com/product-detail/microchip-technology/a54sx32a-fgg256m</a>

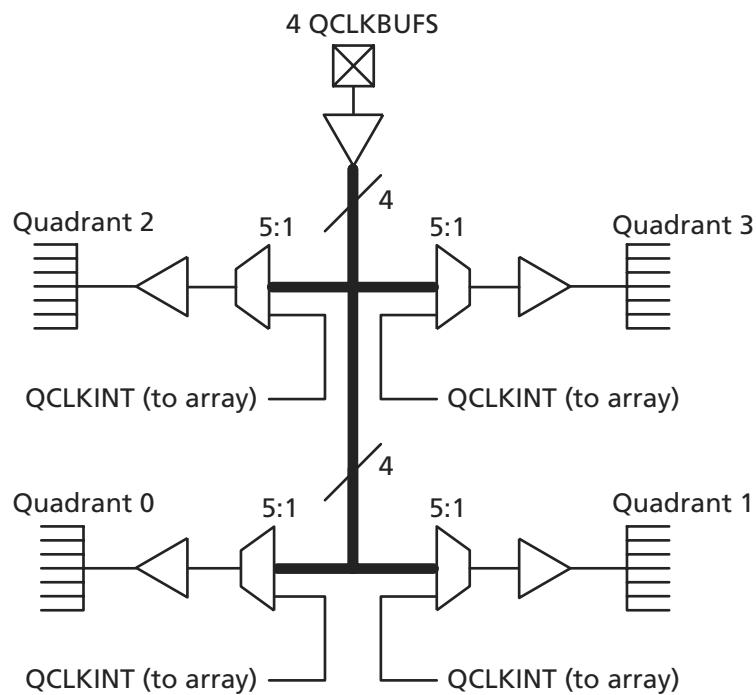


Figure 1-9 • SX-A QCLK Architecture

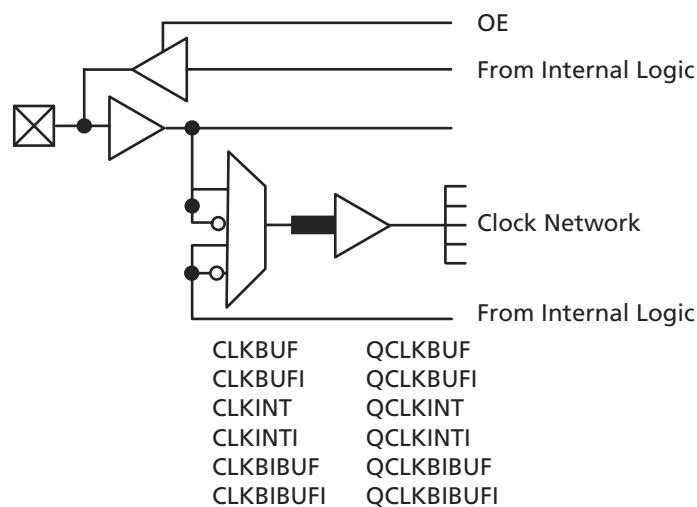


Figure 1-10 • A54SX72A Routed Clock and QCLK Buffer

## Probing Capabilities

SX-A devices also provide an internal probing capability that is accessed with the JTAG pins. The Silicon Explorer II diagnostic hardware is used to control the TDI, TCK, TMS, and TDO pins to select the desired nets for debugging. The user assigns the selected internal nets in Actel Silicon Explorer II software to the PRA/PRB output pins for observation. Silicon Explorer II automatically places the device into JTAG mode. However, probing functionality is only activated when the TRST pin is driven high or left floating, allowing the internal pull-up resistor to pull TRST High. If the TRST pin is held Low, the TAP controller remains in the Test-Logic-Reset state so no probing can be performed. However, the user must drive the TRST pin High or allow the internal pull-up resistor to pull TRST High.

When selecting the **Reserve Probe Pin** box as shown in Figure 1-12 on page 1-9, direct the layout tool to reserve the PRA and PRB pins as dedicated outputs for probing. This **Reserve** option is merely a guideline. If the designer assigns user I/Os to the PRA and PRB pins and selects the **Reserve Probe Pin** option, Designer Layout will override the **Reserve Probe Pin** option and place the user I/Os on those pins.

To allow probing capabilities, the security fuse must not be programmed. Programming the security fuse disables the JTAG and probe circuitry. Table 1-9 summarizes the possible device configurations for probing once the device leaves the Test-Logic-Reset JTAG state.

Table 1-9 • Device Configuration Options for Probe Capability (TRST Pin Reserved)

JTAG Mode	TRST <sup>1</sup>	Security Fuse Programmed	PRA, PRB <sup>2</sup>	TDI, TCK, TDO <sup>2</sup>
Dedicated	Low	No	User I/O <sup>3</sup>	JTAG Disabled
	High	No	Probe Circuit Outputs	JTAG I/O
Flexible	Low	No	User I/O <sup>3</sup>	User I/O <sup>3</sup>
	High	No	Probe Circuit Outputs	JTAG I/O
		Yes	Probe Circuit Secured	Probe Circuit Secured

**Notes:**

1. If the TRST pin is not reserved, the device behaves according to TRST = High as described in the table.
2. Avoid using the TDI, TCK, TDO, PRA, and PRB pins as input or bidirectional ports. Since these pins are active during probing, input signals will not pass through these pins and may cause contention.
3. If no user signal is assigned to these pins, they will behave as unused I/Os in this mode. Unused pins are automatically tristated by the Designer software.

## Design Environment

The SX-A family of FPGAs is fully supported by both Actel Libero® Integrated Design Environment (IDE) and Designer FPGA development software. Actel Libero IDE is a design management environment, seamlessly integrating design tools while guiding the user through the design flow, managing all design and log files, and passing necessary design data among tools. Additionally, Libero IDE allows users to integrate both schematic and HDL synthesis into a single flow and verify the entire design in a single environment. Libero IDE includes Synplify® for Actel from Synplicity®, ViewDraw® for Actel from Mentor Graphics®, ModelSim® HDL Simulator from Mentor Graphics, WaveFormer Lite™ from SynaptiCAD™, and Designer software from Actel. Refer to the *Libero IDE* flow diagram for more information (located on the Actel website).

Actel Designer software is a place-and-route tool and provides a comprehensive suite of backend support tools for FPGA development. The Designer software includes timing-driven place-and-route, and a world-class integrated static timing analyzer and constraints editor. With the Designer software, a user can select and lock package pins while only minimally impacting the results of place-and-route. Additionally, the back-annotation flow is compatible with all the major simulators and the simulation results can be cross-probed with Silicon Explorer II, Actel's integrated verification and logic analysis tool. Another tool included in the Designer software is the SmarGen core generator, which easily creates popular and commonly used logic functions for implementation in your schematic or HDL design. Actel's Designer software is compatible with the most popular FPGA design entry and verification tools from companies such as Mentor Graphics, Synplicity, Synopsys, and Cadence Design Systems. The Designer software is available for both the Windows and UNIX operating systems.

## Programming

Device programming is supported through Silicon Sculptor series of programmers. In particular, Silicon Sculptor is compact, robust, single-site and multi-site device programmer for the PC.

With standalone software, Silicon Sculptor allows concurrent programming of multiple units from the same PC, ensuring the fastest programming times possible. Each fuse is subsequently verified by Silicon Sculptor II to insure correct programming. In addition, integrity tests ensure that no extra fuses are programmed. Silicon Sculptor also provides extensive hardware self-testing capability.

The procedure for programming an SX-A device using Silicon Sculptor is as follows:

1. Load the .AFM file
2. Select the device to be programmed
3. Begin programming

When the design is ready to go to production, Actel offers device volume-programming services either through distribution partners or via in-house programming from the factory.

For detailed information on programming, read the following documents *Programming Antifuse Devices* and *Silicon Sculptor User's Guide*.

# Thermal Characteristics

## Introduction

The temperature variable in Actel Designer software refers to the junction temperature, not the ambient, case, or board temperatures. This is an important distinction because dynamic and static power consumption will cause the chip's junction to be higher than the ambient, case, or board temperatures. EQ 2-9 and EQ 2-10 give the relationship between thermal resistance, temperature gradient and power.

$$\theta_{JA} = \frac{T_J - T_A}{P}$$

EQ 2-9

$$\theta_{JC} = \frac{T_C - T_A}{P}$$

EQ 2-10

Where:

$\theta_{JA}$  = Junction-to-air thermal resistance

$\theta_{JC}$  = Junction-to-case thermal resistance

$T_J$  = Junction temperature

$T_A$  = Ambient temperature

$T_C$  = Case temperature

P = total power dissipated by the device

Table 2-12 • Package Thermal Characteristics

Package Type	Pin Count	$\theta_{JC}$	$\theta_{JA}$			Units
			Still Air	1.0 m/s 200 ft./min.	2.5 m/s 500 ft./min.	
Thin Quad Flat Pack (TQFP)	100	14	33.5	27.4	25	°C/W
Thin Quad Flat Pack (TQFP)	144	11	33.5	28	25.7	°C/W
Thin Quad Flat Pack (TQFP)	176	11	24.7	19.9	18	°C/W
Plastic Quad Flat Pack (PQFP) <sup>1</sup>	208	8	26.1	22.5	20.8	°C/W
Plastic Quad Flat Pack (PQFP) with Heat Spreader <sup>2</sup>	208	3.8	16.2	13.3	11.9	°C/W
Plastic Ball Grid Array (PBGA)	329	3	17.1	13.8	12.8	°C/W
Fine Pitch Ball Grid Array (FBGA)	144	3.8	26.9	22.9	21.5	°C/W
Fine Pitch Ball Grid Array (FBGA)	256	3.8	26.6	22.8	21.5	°C/W
Fine Pitch Ball Grid Array (FBGA)	484	3.2	18	14.7	13.6	°C/W

**Notes:**

1. The A54SX08A PQ208 has no heat spreader.
2. The SX-A PQ208 package has a heat spreader for A54SX16A, A54SX32A, and A54SX72A.

To determine the heat sink's thermal performance, use the following equation:

$$\theta_{JA(TOTAL)} = \theta_{JC} + \theta_{CS} + \theta_{SA}$$

EQ 2-14

where:

$$\theta_{CS} = 0.37^{\circ}\text{C}/\text{W}$$

= thermal resistance of the interface material between the case and the heat sink, usually provided by the thermal interface manufacturer

$$\theta_{SA} = \text{thermal resistance of the heat sink in } ^{\circ}\text{C}/\text{W}$$

$$\theta_{SA} = \theta_{JA(TOTAL)} - \theta_{JC} - \theta_{CS}$$

EQ 2-15

$$\theta_{SA} = 13.33^{\circ}\text{C}/\text{W} - 3.20^{\circ}\text{C}/\text{W} - 0.37^{\circ}\text{C}/\text{W}$$

$$\theta_{SA} = 9.76^{\circ}\text{C}/\text{W}$$

A heat sink with a thermal resistance of  $9.76^{\circ}\text{C}/\text{W}$  or better should be used. Thermal resistance of heat sinks is a function of airflow. The heat sink performance can be significantly improved with the presence of airflow.

Carefully estimating thermal resistance is important in the long-term reliability of an Actel FPGA. Design engineers should always correlate the power consumption of the device with the maximum allowable power dissipation of the package selected for that device, using the provided thermal resistance data.

Note: The values may vary depending on the application.

## Output Buffer Delays

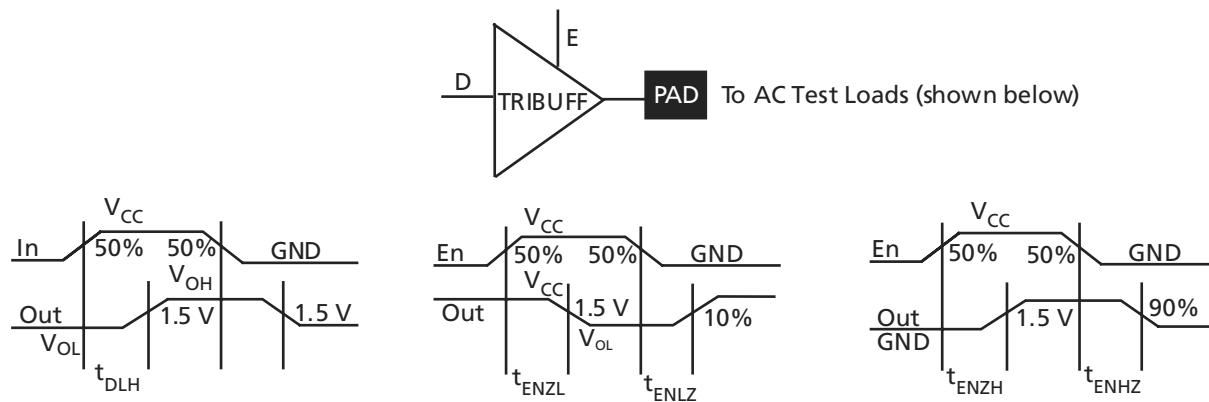


Figure 2-4 • Output Buffer Delays

## AC Test Loads

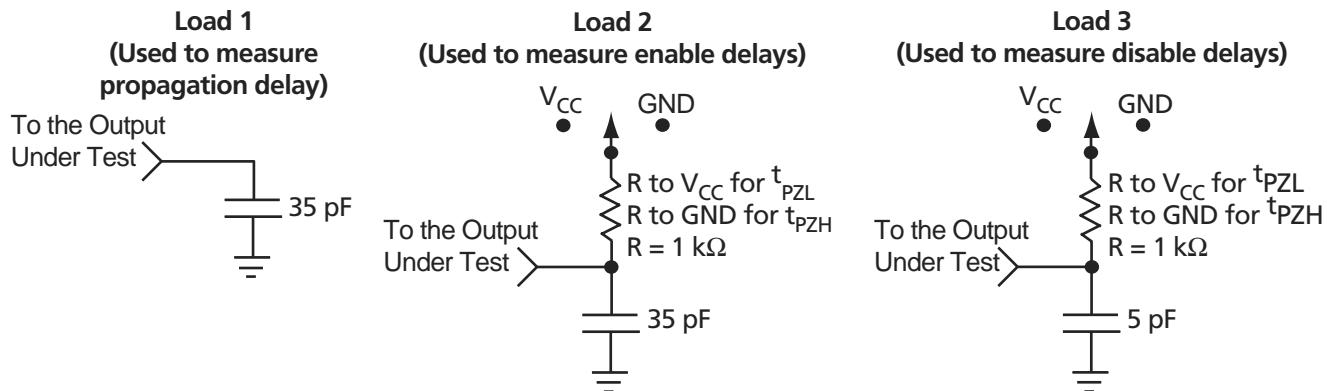


Figure 2-5 • AC Test Loads

## Input Buffer Delays

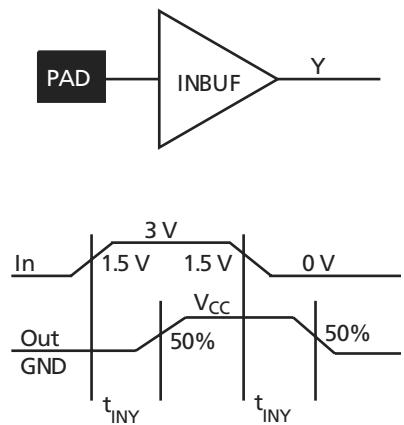


Figure 2-6 • Input Buffer Delays

## C-Cell Delays

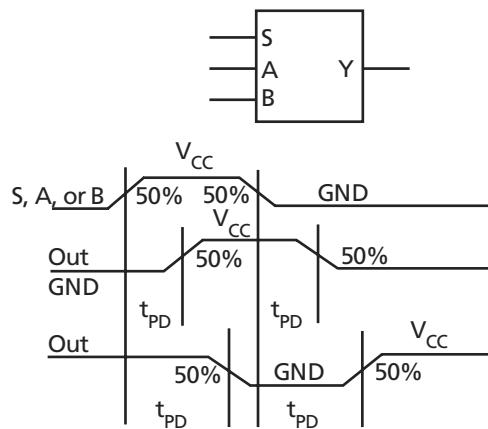


Figure 2-7 • C-Cell Delays

## Cell Timing Characteristics

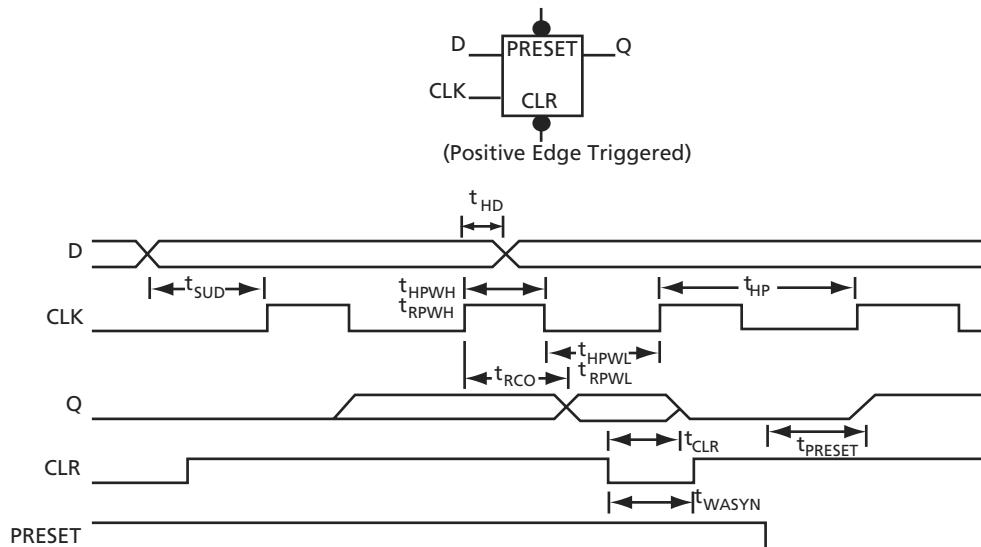


Figure 2-8 • Flip-Flops

Table 2-17 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>								
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2		1.3		1.5		2.3 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.0		1.2		1.4 2.0 ns	
$t_{HPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9 ns
$t_{HPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9 ns
$t_{HCKSW}$	Maximum Skew		0.4		0.4		0.5 0.8 ns	
$t_{HP}$	Minimum Period	3.2		3.6		4.2		5.8 ns
$f_{HMAX}$	Maximum Frequency		313		278		238 172 MHz	
<b>Routed Array Clock Networks</b>								
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	0.9		1.0		1.2		1.7 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.5		1.7		2.0 2.7 ns	
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	0.9		1.0		1.2		1.7 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.5		1.7		2.0		2.7 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.1		1.3		1.5		2.1 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.6		1.8		2.1		2.9 ns
$t_{RPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9 ns
$t_{RPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9 ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.8		0.9		1.1 1.5 ns	
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8		1.0		1.1		1.5 ns
$t_{RCKSW}$	Maximum Skew (100% Load)	0.9		1.0		1.2		1.7 ns

Table 2-19 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>3.3 V PCI Output Module Timing<sup>1</sup></b>								
$t_{DLH}$	Data-to-Pad Low to High	2.2	2.4	2.9	4.0	ns		
$t_{DHL}$	Data-to-Pad High to Low	2.3	2.6	3.1	4.3	ns		
$t_{ENZL}$	Enable-to-Pad, Z to L	1.7	1.9	2.2	3.1	ns		
$t_{ENZH}$	Enable-to-Pad, Z to H	2.2	2.4	2.9	4.0	ns		
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.8	3.2	3.8	5.3	ns		
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.3	2.6	3.1	4.3	ns		
$d_{TLH}^2$	Delta Low to High	0.03	0.03	0.04	0.045	ns/pF		
$d_{THL}^2$	Delta High to Low	0.015	0.015	0.015	0.025	ns/pF		
<b>3.3 V LVTTL Output Module Timing<sup>3</sup></b>								
$t_{DLH}$	Data-to-Pad Low to High	3.0	3.4	4.0	5.6	ns		
$t_{DHL}$	Data-to-Pad High to Low	3.0	3.3	3.9	5.5	ns		
$t_{DHLS}$	Data-to-Pad High to Low—low slew	10.4	11.8	13.8	19.3	ns		
$t_{ENZL}$	Enable-to-Pad, Z to L	2.6	2.9	3.4	4.8	ns		
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	18.9	21.3	25.4	34.9	ns		
$t_{ENZH}$	Enable-to-Pad, Z to H	3	3.4	4	5.6	ns		
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.3	3.7	4.4	6.2	ns		
$t_{ENHZ}$	Enable-to-Pad, H to Z	3	3.3	3.9	5.5	ns		
$d_{TLH}^2$	Delta Low to High	0.03	0.03	0.04	0.045	ns/pF		
$d_{THL}^2$	Delta High to Low	0.015	0.015	0.015	0.025	ns/pF		
$d_{THLS}^2$	Delta High to Low—low slew	0.053	0.067	0.073	0.107	ns/pF		

**Notes:**

1. Delays based on 10 pF loading and 25  $\Omega$  resistance.
2. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[|LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[|LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
3. Delays based on 35 pF loading.

Table 2-23 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.3	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.6	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.5	2.1	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.4	1.7	2.3	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.7	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-36 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.8	ns
$t_{HPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{HCKSW}$	Maximum Skew	1.4	1.6	1.8	2.1	3.3	ns
$t_{HP}$	Minimum Period	3.0	3.4	4.0	4.6	6.4	ns
$f_{HMAX}$	Maximum Frequency	333	294	250	217	156	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.3	2.6	2.9	3.4	4.8	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.8	3.2	3.7	4.3	6.0	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4	2.8	3.2	3.7	5.2	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.9	3.3	3.8	4.5	6.2	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6	3.0	3.4	4.0	5.6	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	3.1	3.6	4.0	4.7	6.6	ns
$t_{RPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.8	2.1	2.4	2.8	3.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.8	2.1	2.4	2.8	3.9	ns
<b>Quadrant Array Clock Networks</b>							
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.6	3.0	3.4	4.0	5.6	ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.6	3.0	3.3	3.9	5.5	ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.8	3.2	3.6	4.3	6.0	ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.8	3.2	3.6	4.2	5.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-36 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	3.0	3.4	3.9	4.6	6.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.9	3.4	3.8	4.5	6.3	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-37 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>										
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6		1.9		2.1		2.5		3.8 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.7		1.9		2.1		2.5	3.8 ns
$t_{HPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2 ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2 ns
$t_{HCKSW}$	Maximum Skew		1.4		1.6		1.8		2.1	3.3 ns
$t_{HP}$	Minimum Period	3.0		3.4		4.0		4.6		6.4 ns
$f_{HMAX}$	Maximum Frequency		333		294		250		217	156 MHz
<b>Routed Array Clock Networks</b>										
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2		2.6		2.9		3.4		4.8 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		2.8		3.3		3.7		4.3	6.0 ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4		2.8		3.2		3.7		5.2 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		2.9		3.4		3.8		4.5	6.2 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6		3.0		3.4		4.0		5.6 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		3.1		3.6		4.1		4.8	6.7 ns
$t_{RPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2 ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2 ns
$t_{RCKSW}$	Maximum Skew (Light Load)		1.9		2.2		2.5		3	4.1 ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9		2.1		2.4		2.8		3.9 ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9		2.1		2.4		2.8		3.9 ns
<b>Quadrant Array Clock Networks</b>										
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.3		1.5		1.7		1.9		2.7 ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.3		1.5		1.7		2	2.8 ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.5		1.7		1.9		2.2		3.1 ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.5		1.8		2		2.3		3.2 ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-38 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.8	ns
$t_{HPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{HCKSW}$	Maximum Skew	1.4	1.6	1.8	2.1	3.3	ns
$t_{HP}$	Minimum Period	3.0	3.4	4.0	4.6	6.4	ns
$f_{HMAX}$	Maximum Frequency	333	294	250	217	156	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.3	2.6	3.0	3.5	4.9	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.8	3.2	3.6	4.3	6.0	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.5	2.9	3.2	3.8	5.3	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	3.0	3.4	3.9	4.6	6.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6	3.0	3.4	3.9	5.5	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	3.2	3.6	4.1	4.8	6.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9	2.2	2.5	3.0	4.1	ns
<b>Quadrant Array Clock Networks</b>							
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.6	ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.3	1.4	1.6	1.9	2.7	ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.4	1.6	1.8	2.1	3.0	ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.4	1.7	1.9	2.2	3.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-38 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.5	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
145	I/O
146	I/O
147	I/O
148	I/O
149	I/O
150	I/O
151	I/O
152	CLKA
153	CLKB
154	NC
155	GND
156	V <sub>CCA</sub>
157	PRA, I/O
158	I/O
159	I/O
160	I/O
161	I/O
162	I/O
163	I/O
164	I/O
165	I/O
166	I/O
167	I/O
168	I/O
169	V <sub>CCI</sub>
170	I/O
171	I/O
172	I/O
173	I/O
174	I/O
175	I/O
176	TCK, I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
D11	V <sub>CCA</sub>
D12	NC
D13	I/O
D14	I/O
D15	I/O
D16	I/O
D17	I/O
D18	I/O
D19	I/O
D20	I/O
D21	I/O
D22	I/O
D23	I/O
E1	V <sub>CCI</sub>
E2	I/O
E3	I/O
E4	I/O
E20	I/O
E21	I/O
E22	I/O
E23	I/O
F1	I/O
F2	TMS
F3	I/O
F4	I/O
F20	I/O
F21	I/O
F22	I/O
F23	I/O
G1	I/O
G2	I/O
G3	I/O
G4	I/O
G20	I/O
G21	I/O
G22	I/O
G23	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
H1	I/O
H2	I/O
H3	I/O
H4	I/O
H20	V <sub>CCA</sub>
H21	I/O
H22	I/O
H23	I/O
J1	NC
J2	I/O
J3	I/O
J4	I/O
J20	I/O
J21	I/O
J22	I/O
J23	I/O
K1	I/O
K2	I/O
K3	I/O
K4	I/O
K10	GND
K11	GND
K12	GND
K13	GND
K14	GND
K20	I/O
K21	I/O
K22	I/O
K23	I/O
L1	I/O
L2	I/O
L3	I/O
L4	NC
L10	GND
L11	GND
L12	GND
L13	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
L14	GND
L20	NC
L21	I/O
L22	I/O
L23	NC
M1	I/O
M2	I/O
M3	I/O
M4	V <sub>CCA</sub>
M10	GND
M11	GND
M12	GND
M13	GND
M14	GND
M20	V <sub>CCA</sub>
M21	I/O
M22	I/O
M23	V <sub>CCI</sub>
N1	I/O
N2	TRST, I/O
N3	I/O
N4	I/O
N10	GND
N11	GND
N12	GND
N13	GND
N14	GND
N20	NC
N21	I/O
N22	I/O
N23	I/O
P1	I/O
P2	I/O
P3	I/O
P4	I/O
P10	GND
P11	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
P12	GND
P13	GND
P14	GND
P20	I/O
P21	I/O
P22	I/O
P23	I/O
R1	I/O
R2	I/O
R3	I/O
R4	I/O
R20	I/O
R21	I/O
R22	I/O
R23	I/O
T1	I/O
T2	I/O
T3	I/O
T4	I/O
T20	I/O
T21	I/O
T22	I/O
T23	I/O
U1	I/O
U2	I/O
U3	V <sub>CCA</sub>
U4	I/O
U20	I/O
U21	V <sub>CCA</sub>
U22	I/O
U23	I/O
V1	V <sub>CCI</sub>
V2	I/O
V3	I/O
V4	I/O
V20	I/O
V21	I/O

## 256-Pin FBGA

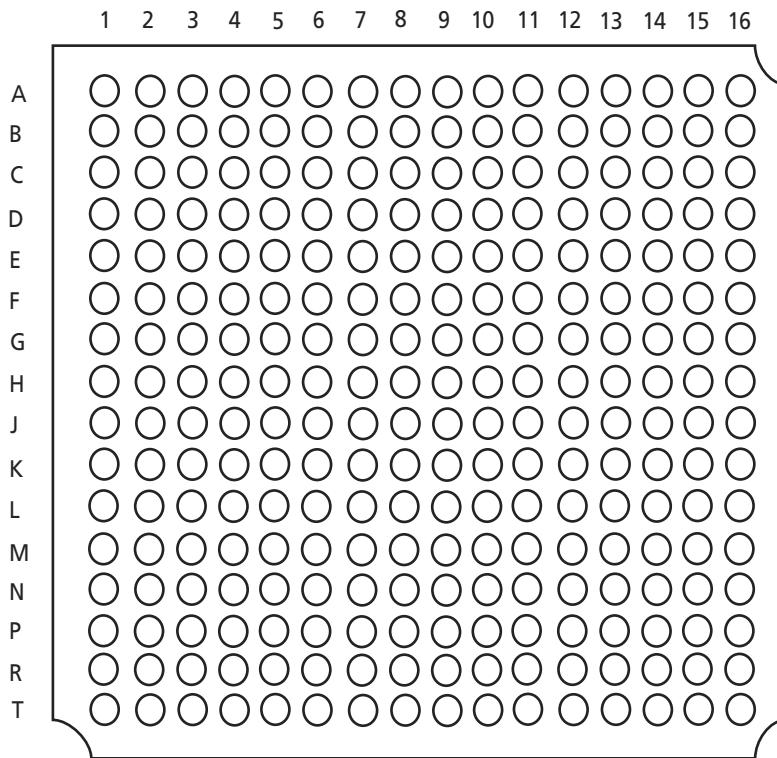


Figure 3-7 • 256-Pin FBGA (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AD18	I/O	I/O
AD19	I/O	I/O
AD20	I/O	I/O
AD21	I/O	I/O
AD22	I/O	I/O
AD23	V <sub>CCI</sub>	V <sub>CCI</sub>
AD24	NC*	I/O
AD25	NC*	I/O
AD26	NC*	I/O
AE1	NC*	NC
AE2	I/O	I/O
AE3	NC*	I/O
AE4	NC*	I/O
AE5	NC*	I/O
AE6	NC*	I/O
AE7	I/O	I/O
AE8	I/O	I/O
AE9	I/O	I/O
AE10	I/O	I/O
AE11	NC*	I/O
AE12	I/O	I/O
AE13	I/O	I/O
AE14	I/O	I/O
AE15	NC*	I/O
AE16	NC*	I/O
AE17	I/O	I/O
AE18	I/O	I/O
AE19	I/O	I/O
AE20	I/O	I/O
AE21	NC*	I/O
AE22	NC*	I/O
AE23	NC*	I/O
AE24	NC*	I/O
AE25	NC*	NC
AE26	NC*	NC

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AF1	NC*	NC
AF2	NC*	NC
AF3	NC	I/O
AF4	NC*	I/O
AF5	NC*	I/O
AF6	NC*	I/O
AF7	I/O	I/O
AF8	I/O	I/O
AF9	I/O	I/O
AF10	I/O	I/O
AF11	NC*	I/O
AF12	NC*	NC
AF13	HCLK	HCLK
AF14	I/O	QCLKB
AF15	NC*	I/O
AF16	NC*	I/O
AF17	I/O	I/O
AF18	I/O	I/O
AF19	I/O	I/O
AF20	NC*	I/O
AF21	NC*	I/O
AF22	NC*	I/O
AF23	NC*	I/O
AF24	NC*	I/O
AF25	NC*	NC
AF26	NC*	NC
B1	NC*	NC
B2	NC*	NC
B3	NC*	I/O
B4	NC*	I/O
B5	NC*	I/O
B6	I/O	I/O
B7	I/O	I/O
B8	I/O	I/O
B9	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
B10	I/O	I/O
B11	NC*	I/O
B12	NC*	I/O
B13	V <sub>CCI</sub>	V <sub>CCI</sub>
B14	CLKA	CLKA
B15	NC*	I/O
B16	NC*	I/O
B17	I/O	I/O
B18	V <sub>CCI</sub>	V <sub>CCI</sub>
B19	I/O	I/O
B20	I/O	I/O
B21	NC*	I/O
B22	NC*	I/O
B23	NC*	I/O
B24	NC*	I/O
B25	I/O	I/O
B26	NC*	NC
C1	NC*	I/O
C2	NC*	I/O
C3	NC*	I/O
C4	NC*	I/O
C5	I/O	I/O
C6	V <sub>CCI</sub>	V <sub>CCI</sub>
C7	I/O	I/O
C8	I/O	I/O
C9	V <sub>CCI</sub>	V <sub>CCI</sub>
C10	I/O	I/O
C11	I/O	I/O
C12	I/O	I/O
C13	PRA, I/O	PRA, I/O
C14	I/O	I/O
C15	I/O	QCLKD
C16	I/O	I/O
C17	I/O	I/O
C18	I/O	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
K10	GND	GND
K11	GND	GND
K12	GND	GND
K13	GND	GND
K14	GND	GND
K15	GND	GND
K16	GND	GND
K17	GND	GND
K22	I/O	I/O
K23	I/O	I/O
K24	NC*	NC
K25	NC*	I/O
K26	NC*	I/O
L1	NC*	I/O
L2	NC*	I/O
L3	I/O	I/O
L4	I/O	I/O
L5	I/O	I/O
L10	GND	GND
L11	GND	GND
L12	GND	GND
L13	GND	GND
L14	GND	GND
L15	GND	GND
L16	GND	GND
L17	GND	GND
L22	I/O	I/O
L23	I/O	I/O
L24	I/O	I/O
L25	I/O	I/O
L26	I/O	I/O
M1	NC*	NC
M2	I/O	I/O
M3	I/O	I/O
M4	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
M5	I/O	I/O
M10	GND	GND
M11	GND	GND
M12	GND	GND
M13	GND	GND
M14	GND	GND
M15	GND	GND
M16	GND	GND
M17	GND	GND
M22	I/O	I/O
M23	I/O	I/O
M24	I/O	I/O
M25	NC*	I/O
M26	NC*	I/O
N1	I/O	I/O
N2	V <sub>CCI</sub>	V <sub>CCI</sub>
N3	I/O	I/O
N4	I/O	I/O
N5	I/O	I/O
N10	GND	GND
N11	GND	GND
N12	GND	GND
N13	GND	GND
N14	GND	GND
N15	GND	GND
N16	GND	GND
N17	GND	GND
N22	V <sub>CCA</sub>	V <sub>CCA</sub>
N23	I/O	I/O
N24	I/O	I/O
N25	I/O	I/O
N26	NC*	NC
P1	NC*	I/O
P2	NC*	I/O
P3	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
P4	I/O	I/O
P5	V <sub>CCA</sub>	V <sub>CCA</sub>
P10	GND	GND
P11	GND	GND
P12	GND	GND
P13	GND	GND
P14	GND	GND
P15	GND	GND
P16	GND	GND
P17	GND	GND
P22	I/O	I/O
P23	I/O	I/O
P24	V <sub>CCI</sub>	V <sub>CCI</sub>
P25	I/O	I/O
P26	I/O	I/O
R1	NC*	I/O
R2	NC*	I/O
R3	I/O	I/O
R4	I/O	I/O
R5	TRST, I/O	TRST, I/O
R10	GND	GND
R11	GND	GND
R12	GND	GND
R13	GND	GND
R14	GND	GND
R15	GND	GND
R16	GND	GND
R17	GND	GND
R22	I/O	I/O
R23	I/O	I/O
R24	I/O	I/O
R25	NC*	I/O
R26	NC*	I/O
T1	NC*	I/O
T2	NC*	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.